

**AMENDMENTS TO THE SPECIFICATION**

**Please replace the present title with the following amended title:**

**PROCESS FOR PRODUCING MULTILAYER PRINTED WIRING BOARD**

**Amend the specification by adding on page 1, before “TECHNICAL FIELD”, insert:**

**CROSS-REFERENCE TO RELATED APPLICATIONS**

This application is the U.S. National Phase application under 35 U.S.C. § 371 of International Application No. PCT/JP03/16377, filed 12/19/03, which claims priority to Japanese Patent Application Nos. 2003-11635, filed 01/20/03, 2003-294994, filed 08/19/03, 2003-309254, filed 09/01/03 and 2003-342907, filed 10/01/03.”